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Sustainable partment computing solutions: | ICH a case-study of the | Pro LHCb data-centre

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Acknowledgements & Disclaimers



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Power-saving is only a part of LHCb's comprehensive environmental impact strategy

Why do we care about computing?





LHCb detector < **0.3 MW** (excluding the magnet)

LHCb DAQ + High Level Trigger **1.4 MW** LHCb Magnet 4.4 MW



Side remark – the value of density



Physical proximity is one of the most effective means to safe cost in data-centre

 Fast connections (> 10 Gbit/s) are usually factors cheaper when they remain within 3 meters. Short connections also consume less energy

It is beneficial to have a high density of equipment, this drives the power-dissipation density up

There is a completely analogous trend within the compute equipment itself: it is much more power- and cost efficient to have more cores, logical elements, memory in a single CPU, GPU, FPGA package —> consequently modern high-end chips dissipate 500 Ws and more(!)

Energy usage in a datacentre



 The data-centre infrastructure: cables, fans,, lights, pumps, watertreatment, electrical switch-boards

- The computers: CPUs, power-supplies, fans, memories
- Add-in cards: GPUs, NICs, FGPAs,
- Storage: drives, controllers,
- Network equipment: switches, physical interfaces (PHYs), cables

Core metric = Power Usage Efficiency

PUE = Total power consumed by the data-centre

Total power consumed by IT equipment



How can we do better?



Less compute

More energy-efficient compute

Energy re-use

Energy efficient data-centre / infrastructure —> this talk



How to cool?



Main heat dissipating unit are compute servers pushing hot air out at the rear of a metallic enclosure

Network equipment behaves the same for the purpose of this consideration.

We have disregarded direct liquid cooling solutions for the time being since it seemed to early at the time of planning (2017)

==> Head-load is all hot air :-) which needs to be cooled

Can be done directly (expansion cooling, quite inefficient) or by taking the air into water or by evacuating the hot air into the environment ("free cooling")

> Water cooled passive or active (with fans) doors mounted on the rear of racks Necessary piping work at LHC Point 8 made these solutions cost-wise unattractive



Server needs



Defined by	
ASHRAE (American Society of Heating, Refrigerating	Recommended
and Air Conditioning Engineers)	A1
recommends a maximum of 27 °C (low	A2
consumption, risk of failure very low).	A3
But have also defined environmental	A4
envelopes (Class A1, A2, A3, A4)	
The manufactures use the Class to	
define their specs.	
Servers compliant with 'ASHRAE Class	
A3 or A4' are available, but less	
common	

Also servers dissipate more heat when running at higher inlet temperatures

LHCb targets PUE < 1.1 within A2 envelope

	Temperat [°(ture range C]	Humidity range		Max. dew point [°C]
Recommended	18	27	$5.5^{\circ}C$ DP	60% RH, $15^{\rm o}{\rm C}$ DP	
A1	15	32	20% RH	80% RH	17
A2	10	35	20% RH	$80\% \mathrm{RH}$	21
A3	5	40	-12°C DP, 8% RH	85% RH	24
A4	5	45	-12°C DP, 8% RH	90% RH	24





- (Almost) Always in the A2 envelope
- Compatible with 'Direct Free AIR cooling'
- Compatible with 'Indirect Free AIR cooling' (with additional adiabatic cooling for summer)

 \Box advantages with 'Indirect' solution: Air filtration easier, better control of the air temperature inlet.

Indirect Free Air Cooling



Outside Fans running 0-20% - 70%



Winning solution after tendering

LHC

Modular Data Centre' consisting of single row modules (shaped like a container but larger than standard shipping container)

LHCb: 7 Modules 6 IT: 18m x 4m x 6,5m height 1 Power + Water : 18m x 3,5m x 3m height

- Up to ~ 20kW/rack (85%)
- Up to ~ 40kW/rack (15%)
- Designed for a total power of 2.3 MW

2 full redundant Power supplies (2 transformers 3.15 MVA, 2 main switchboards, 2 secondary switchboards, 2 PDU per rack)

- Two event-builder modules with 18 racks (800 mm wide).
- Four event-filter modules with 24 racks (600 mm wide).
- 132 racks in total (6336 rack units).



Event-filter module.



Event-builder module.

Transformers & Power module





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LHCb site





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Units





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Inside the IT modules





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Geneva



LHCb THCp ONLINE

For a full year, the outside air is below 20 °C most of the time

□ 'Dry mode' (without water) is sufficient for a large fraction of the time during a year —> reduces water consumption



Internal temperature stability



Ex: air supply in IT2 module in 2022



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Regulation

Goal
have a 27 °C inlet server temperature, as stable as possible, independently of **Outside temperature**, humidity & Load of servers

- Parameters for each AHU:
- Outside fan speeds
 - minimum 20%, high speeds clog more quickly the air filters
- Inside fan speeds
 - adjusted to have a good delta T temperature for the best Air/Air exchanger efficiency
- Water pumps speeds (in Summer mode)
 - enough to well cover the heat exchanger but not too high (water consumption)
- Influence of the air filters status
 - regular maintenance needed
- Trade-off between PUE and water-consumption





Air filters improvement



Overall efficiency LHCb DC





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Water consumption



30 days in July 202327C set-point interior1.9 MW average total power



513 kW total load @ 27C vs PUE



Final thoughts



 A lot of factors contribute to the environmental impact of the LHCb Online system

 We have decided to go for a quite efficient infrastructure based on indirect free air-cooling. We consistently achieve a PUE < 1.1

For the future we will

- try to reduce water-usage
- optimise configuration of cluster
- investigate different CPU / GPU architectures
- prepare for the use of direct liquid cooling
- check energy-reuse possibilities with CERN EN department

Lessons learned will influence final choices for LHCb upgrade
 II for Run5 and Run6



More material

Energy efficient compute



>We can configure *power-savings options on existing hardware.* Clock-frequencies will be capped and parts of the hardware will be put automatically into a low power-state when they're not used

Consequences:

- a certain loss in overall performance (to be measured),
- a certain loss in "responsiveness" of the system to load-changes Most likely irrelevant for asynchronous, batch-style processing unclear for quasi-realtime / I/O work-loads unacceptable for ECS / slow-controls

Shift to more energy efficient compute



➤ Use more energy efficient CPUs → accept increased price. Example from upcoming Intel server CPUs: for a 44% increase in cost, 25% reduction in energy consumption (TDP). These numbers are based on nominal power-dissipation and listprices. The power savings must be measured with a realistic application and the cost-increase must be probed in a competitive procurement exercise

Use allegedly more efficient ISAs, ARM, RISCV—> TCO in terms of money and energy must be determined by benchmarking (not on paper).

> Use GPGPUs or FPGAs also for HLT2 → algorithms must be available for a comparison. In GPU-friendly applications the power-savings are typically at least 50%, cost-savings depend again on competitiveness of procurement procedure → for GPGPUs would be crucial to be able to run on Nvidia, AMD AND Intel GPUs. Ceteris paribus same goes for FPGAs

Improved cooling of the servers

- Direct Contact Liquid Cooling
 - Better potential for energy reuse (warm water)
 - Energy savings due to reduced fan-speed (to be benchmarked)





- Immersion Cooling
 - drastic change of infrastructure
 - only rack-level
 - rather higher up-front cost



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